

Customer Information Notification

Issue Date: 20-Dec-2018 Effective Date: 21-Dec-2018

Dear Emma Tempest,

Here's your personalized quality information concerning products Premier Farnell PLC purchased from NXP.

For detailed information we invite you to view this notification online

This notice is NXP Company Proprietary.

201810023I



| Change | Category |
|--------|----------|
|--------|----------|

| 3 3 3 3 3 3 | | | | |
|------------------------|-------------|---------------------------|-----------|----------------|
| [] Wafer Fab Process | [] Assembly | [] Product Marking | []Test | [] Design |
| | Process | | Location | |
| [] Wafer Fab Materials | [] Assembly | [] Mechanical | []Test | [] Errata |
| | Materials | Specification | Process | |
| [] Wafer Fab Location | [] Assembly | Γİ | []Test | [X] Electrical |
| | Location | Packing/Shipping/Labeling | Equipment | spec./Test |
| | | | | coverage |

[] Firmware

[X] Other - Safety Manual

MPC5777C Reference Manual and Safety Manual Update

Description

NXP Semiconductors announces a Reference Manual (RM) update for the MPC5777C to revision 8.1 and a Safety Manual (SM) update to revision 3. The Reference Manual change is the addition of Reference Manual Addendum revision 2. The Safety Manual provides a detailed description of its changes.

The Reference Manual and Safety Manual for MPC5777C can be found at

https://www.nxp.com/products/processors-and-microcontrollers/power-architecture-processors/mpc5xxx-55xx-32-bit-mcus/ultra-reliable-mpc57xx-32-bit-automotive-and-industrial-microcontrollers-mcus/ultra-reliable-mpc5777c-mcu-for-automotive-industrial-engine-management:MPC5777C?tab=Documentation Tab

Corresponding ZVEI Delta Qualification Matrix ID: SEM-DS-02

Reason

The Reference Manual and Safety Manual have been updated to correct errors and / or provide additional technical clarification on some device features.

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

Additional information

Affected products and sales history information; see attached file

Additional documents: view online

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name NXP Technical Support e-mail address tech.support@nxp.com

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Customer Focus, Passion to Win.

NXP Quality Management Team.

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